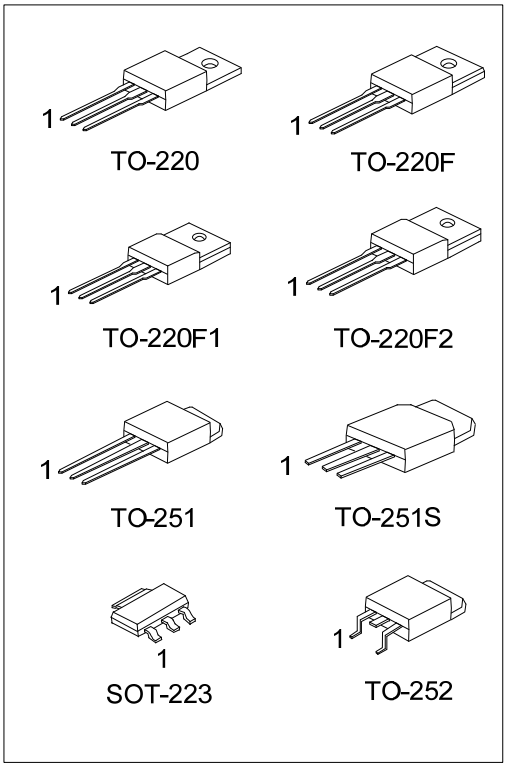
2A, 700V N-CHANNEL POWER MOSFET



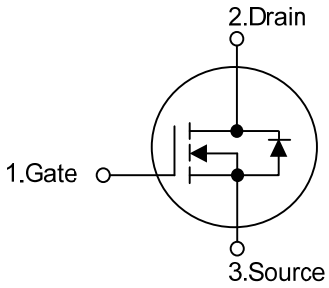
■ DESCRIPTION

The UTC **2N70-CB** is a high voltage MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

■ FEATURES

* $R_{DS(ON)}$ < 6.0Ω @ V_{GS} = 10V , I_D = 1.0 A
* Fast switching capability
* Avalanche energy specified
* Improved dv/dt capability, high ruggedness

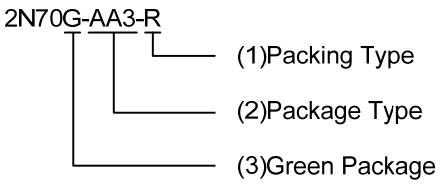
■ SYMBOL



■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
2N70L-AA3-R	2N70G-AA3-R	SOT-223	G	D	S	Tape Reel
2N70L-TA3-T	2N70G-TA3-T	TO-220	G	D	S	Tube
2N70L-TF1-T	2N70G-TF1-T	TO-220F1	G	D	S	Tube
2N70L-TF1-T	2N70G-TF1-T	TO-220F1	G	D	S	Tube
2N70L-TF3-T	2N70G-TF3-T	TO-220F	G	D	S	Tube
2N70L-TM3-T	2N70G-TM3-T	TO-251	G	D	S	Tube
2N70L-TMS-T	2N70G-TMS-T	TO-251S	G	D	S	Tube
2N70L-TN3-R	2N70G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

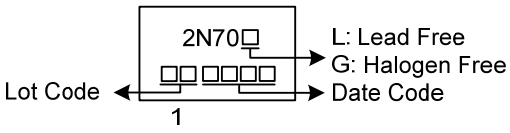
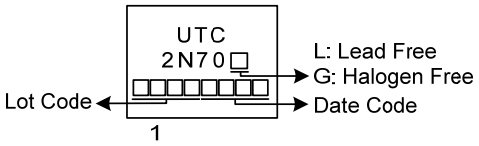


(1) T: Tube, R: Tape Reel

(2) AA3: SOT-223, TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TF2: TO-220F2, TM3: TO-251, TMS: TO-251S, TN3: TO-252

(3) G: Halogen Free and Lead Free, L: Lead Free

■ MARKING

SOT-223	TO-220 / TO-220F / TO-220F1 / TO-220F2 TO-251 / TO-251S /TO-252
	

■ ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	700	V
Gate-Source Voltage		V_{GSS}	±30	V
Drain Current	Continuous	I_D	2.0	A
	Pulsed (Note 2)	I_{DM}	8.0	A
Avalanche Current (Note 2)		I_{AR}	2.4	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	29	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2.75	V/ns
Power Dissipation	SOT-223	P_D		W
	TO-220		45	W
	TO-220F/TO-220F1 TO-220F2		28	W
	TO-251/TO-251S TO-252		30	W
Junction Temperature		T_J	+150	°C
Storage Temperature		T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive Rating : Pulse width limited by maximum junction temperature.
3. L=10mH, I_{AS}=2.4A, V_{DD}=50V, R_G=25 Ω, Starting T_J = 25°C
4. I_{SD}≤2.0A, di/dt≤200A/μs, V_{DD}≤ BV_{DSS}, Starting T_J = 25°C

■ THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	SOT-223	θ_{JA}		°C/W
	TO-220/TO-220F TO-220F1/TO-220F2		62.5	°C/W
	TO-251/TO-251S TO-252		110	°C/W
Junction to Case	SOT-223	θ_{JC}		°C/W
	TO-220		2.78	°C/W
	TO-220F/TO-220F1 TO-220F2		4.46	°C/W
	TO-251/TO-251S TO-252		4.17	°C/W

■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	V_{GS} = 0V, I_D = 250μA	700			V
Drain-Source Leakage Current		I_{DSS}	V_{DS} = 700V, V_{GS} = 0V			1	μA
Gate-Source Leakage Current	Forward	I_{GSS}	V_{GS} = 30V, V_{DS} = 0V			100	nA
	Reverse		V_{GS} = -30V, V_{DS} = 0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	V_{DS} = V_{GS}, I_D = 250μA	2.0		4.0	V
Static Drain-Source On-State Resistance		$R_{DS(ON)}$	V_{GS} = 10V, I_D =1.0A			6.0	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		C_{ISS}	V_{GS} =0V, V_{DS} =25V, f =1MHz		295		pF
Output Capacitance		C_{OSS}			31		pF
Reverse Transfer Capacitance		C_{RSS}			5		pF
SWITCHING CHARACTERISTICS							
Total Gate Charge (Note 1)		Q_G	V_{DS}=50V, V_{GS}=10V, I_D=1.3A I_G=100μA (Note 1, 2)		28		nC
Gate to Source Charge		Q_{GS}			1.6		nC
Gate to Drain Charge		Q_{GD}			1.4		nC
Turn-ON Delay Time (Note 1)		$t_{D(ON)}$	V_{DS}=30V, V_{GS}=10V, I_D=0.5A, R_G =25Ω (Note 1, 2)		36		ns
Rise Time		t_R			24		ns
Turn-OFF Delay Time		$t_{D(OFF)}$			86		ns
Fall-Time		t_F			27		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Pulsed Current		I_{SD}				2.0	A
Drain-Source Diode Forward Voltage (Note 1)		I_{SM}				8.0	A
Maximum Body-Diode Continuous Current		V_{SD}	V_{GS} = 0 V, I_{SD} = 2.0 A			1.4	V
Body Diode Reverse Recovery Time (Note 1)		t_{rr}	V_{GS} = 0V, I_S = 2.0A, dI_F / dt =100A/μs		315		nS
Body Diode Reverse Recovery Charge		Q_{rr}			0.8		μC

Notes: 1. Pulse Test: Pulse width ≤ 300μs, Duty cycle≤2%
2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

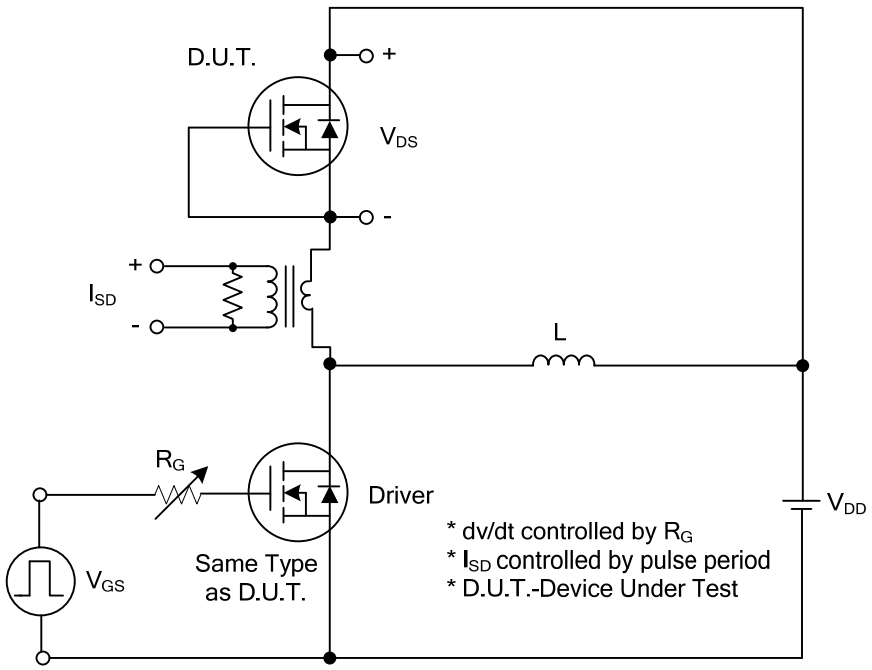


Fig. 1A Peak Diode Recovery dv/dt Test Circuit

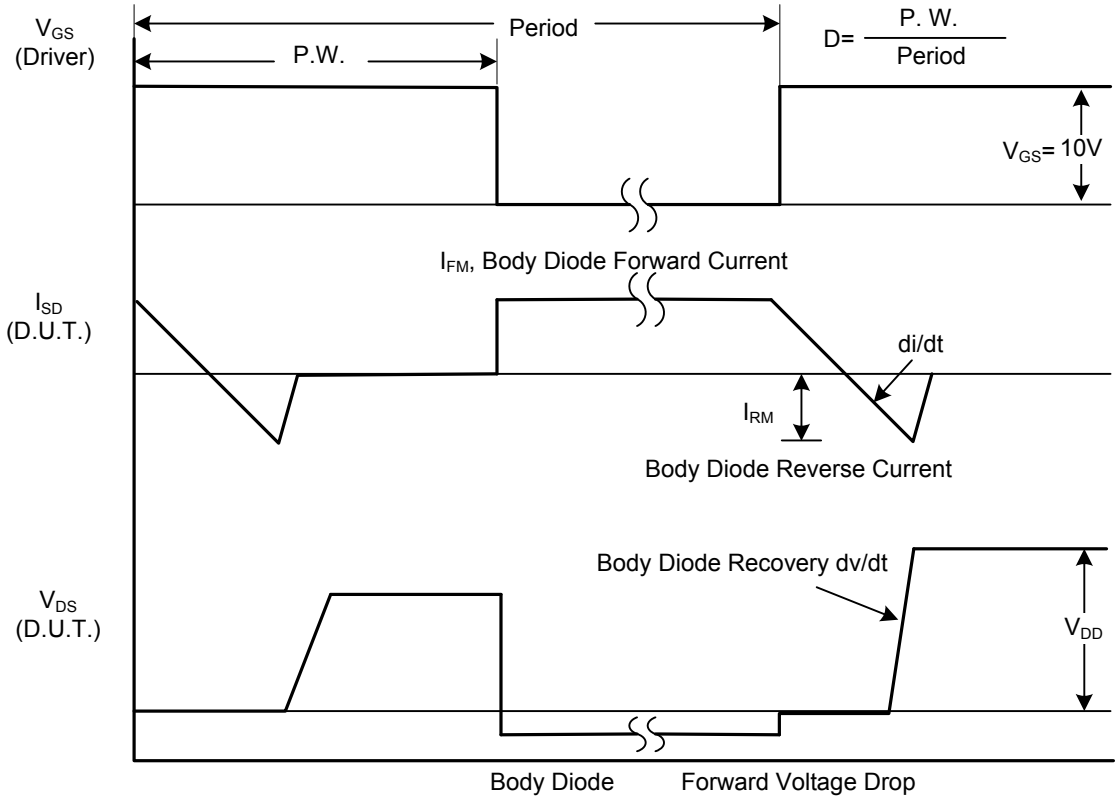


Fig. 1B Peak Diode Recovery dv/dt Waveforms

■ TEST CIRCUITS AND WAVEFORMS

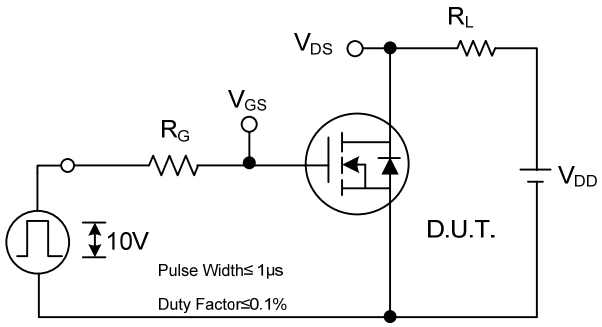


Fig. 2A Switching Test Circuit

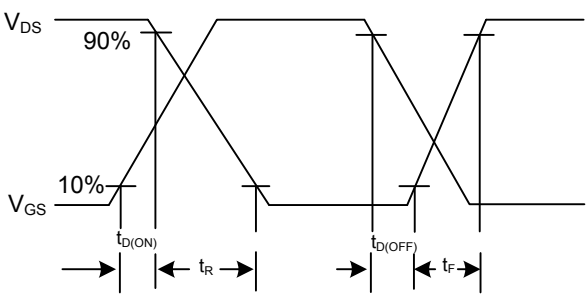


Fig. 2B Switching Waveforms

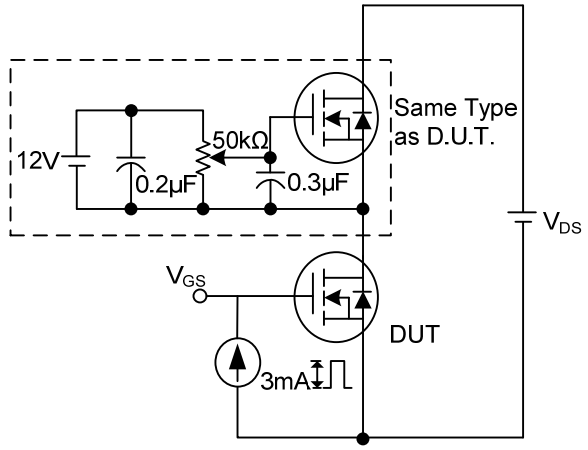


Fig. 3A Gate Charge Test Circuit

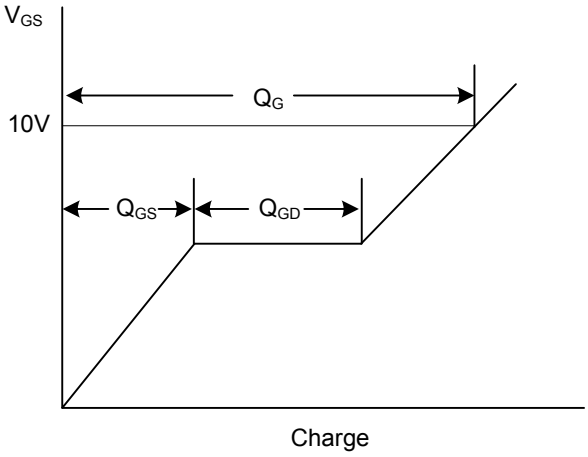


Fig. 3B Gate Charge Waveform

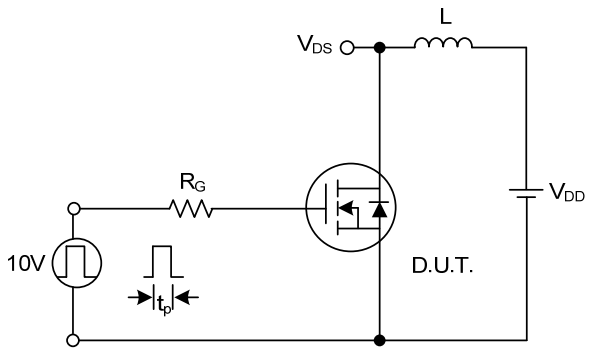


Fig. 4A Unclamped Inductive Switching Test Circuit

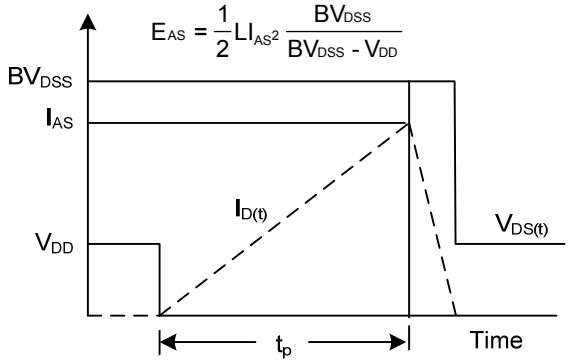


Fig. 4B Unclamped Inductive Switching Waveforms